CY2278A

Pentium®/II Clock Synthesizer/Driver for Mobile PCs with Intel® 82430TX and No SDRAM

Features

- **Mixed 2.5V and 3.3V operation**
- **Complete clock solution to meet requirements of mobile Pentium® and Pentium® II motherboards**
  - **Seven CPU clock outputs (three at 3.3V, and four at 2.5V or 3.3V) with eight selectable clock frequencies.**
  - **Ten 3.3V synchronous PCI clock outputs**
  - **Two 3.3V USB/IR clocks at 48 MHz**
  - **One Keyboard clock at 8 MHz**
  - **One 2.5V IOAPIC clock at 14.318 MHz**
  - **Two 3.3V Ref. clocks at 14.318 MHz**
- **Dedicated power management for portable systems**
  - **Separate output enable pins for CPU, PCI, and USB/IR clock sets**
  - **Free-running PCI and CPU clocks (see options)**
- **Factory-EPROM programmable output drive and slew rate for EMI customization**
- **Custom configuration with factory-EPROM programmable CPU, PCI, and USB/IR frequencies.**
- **Low skew and low jitter outputs**
- **Available in space-saving 48-pin TSSOP package**

Functional Description

The CY2278A is a Clock Synthesizer/Driver chip for Pentium or Pentium II portable PCs designed with the 82430TX or similar core-logic chipsets. There are four options available as shown in the selector guide.

The CY2278A outputs seven CPU clocks, three of which run at 3.3V and four run at either 2.5V or 3.3V, depending on the

voltage applied on pin 42. There are ten PCI clocks, running at one half the CPU clock frequency. Free-running PCI and CPU clocks are available as options shown in the selector guide. Additionally, the part outputs two 3.3V USB/IR clocks at 48 MHz, one Keyboard clock at 8 MHz, one 2.5V IOAPIC clock at 14.318 MHz, and two 3.3V reference clocks at 14.318 MHz.

The CY2278 family contains several features for output flexibility and power control. The CPU, PCI, USB and IR clock frequencies are all factory EPROM-programmable. Three hardware select inputs support eight CPU clock frequencies from 20–75 MHz. Additionally, each of the CPU, PCI, and USB/IR clock sets can be turned on or off with a dedicated enable input pin for power management.

The CY2278A outputs are designed for low EMI emissions. Controlled rise and fall times, unique output driver circuits and factory-EPROM programmable output drive and slew-rate enable optimal configurations for EMI control.
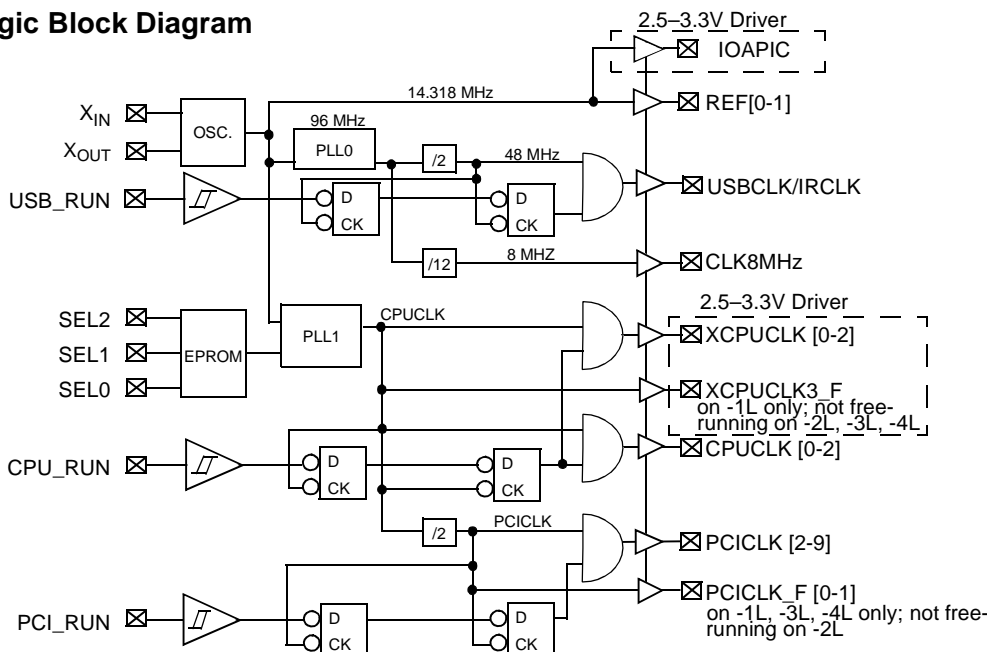
CY2278A Selector Guide

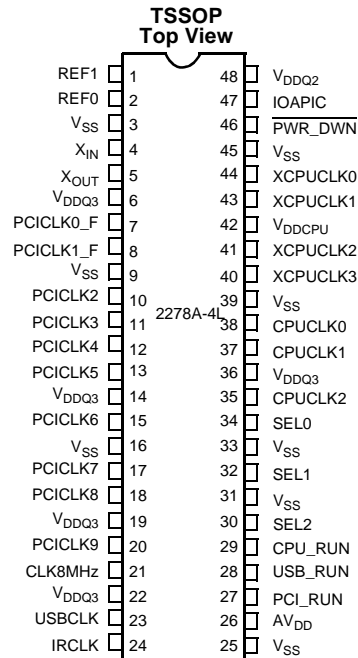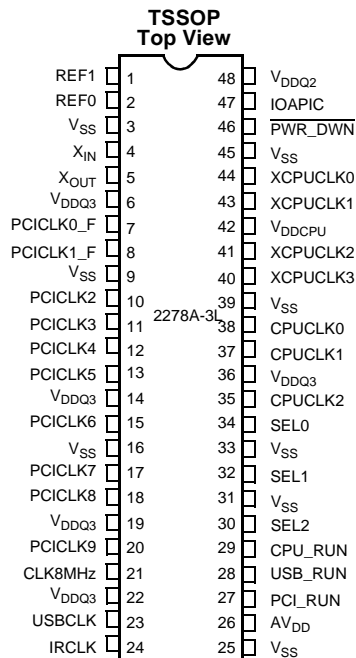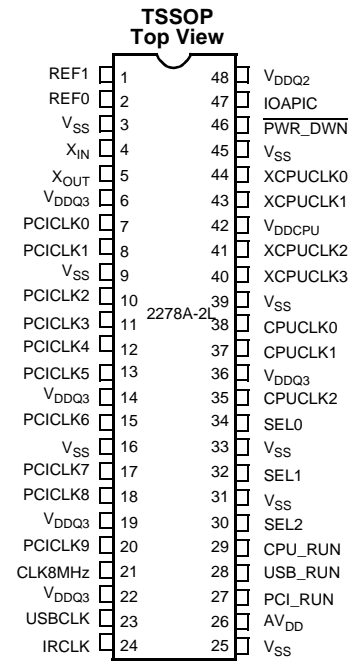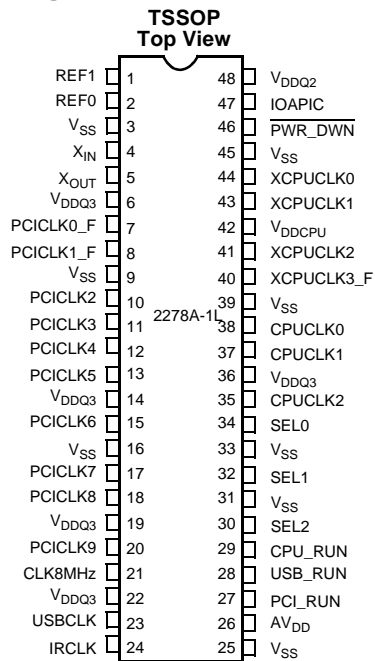| Clock Outputs	-1L	-2L	-3L	-4L
CPU@3.3V	3	3	3	3
CPU@2.5/3.3V	4[1]	4	4	4
PCI (CPU/2 MHz)	10[2]	10	10[2]	10[2]
USB/IR (48 MHz)	2	2	2	2
KB (8 MHz)	1	1	1	1
IOAPIC (14.318 MHz)	2	2	2	2
Ref (14.318 MHz)	2	2	2	2
CPU-PCI delay	0 ns	0 ns	1–5 ns	0 ns

Notes:
1. One free-running CPU clock.
2. Two free-running PCI clocks.

Logic Block Diagram

Intel and Pentium are registered trademarks of Intel Corporation.

Cypress Semiconductor Corporation • 3901 North First Street • San Jose • CA 95134 • 408-943-2600
Document #: 38-07211 Rev. *A
Revised Decemeber 07, 2002

Pin Configurations

TSSOP Top View — 2278A-1L

Pin	Signal		Pin	Signal
1	REF1		48	V_DDQ2
2	REF0		47	IOAPIC
3	V_SS		46	$\overline{PWR\_DWN}$
4	X_IN		45	V_SS
5	X_OUT		44	XCPUCLK0
6	V_DDQ3		43	XCPUCLK1
7	PCICLK0_F		42	V_DDCPU
8	PCICLK1_F		41	XCPUCLK2
9	V_SS		40	XCPUCLK3_F
10	PCICLK2		39	V_SS
11	PCICLK3		38	CPUCLK0
12	PCICLK4		37	CPUCLK1
13	PCICLK5		36	V_DDQ3
14	V_DDQ3		35	CPUCLK2
15	PCICLK6		34	SEL0
16	V_SS		33	V_SS
17	PCICLK7		32	SEL1
18	PCICLK8		31	V_SS
19	V_DDQ3		30	SEL2
20	PCICLK9		29	CPU_RUN
21	CLK8MHz		28	USB_RUN
22	V_DDQ3		27	PCI_RUN
23	USBCLK		26	AV_DD
24	IRCLK		25	V_SS

TSSOP Top View — 2278A-2L

Pin	Signal		Pin	Signal
1	REF1		48	V_DDQ2
2	REF0		47	IOAPIC
3	V_SS		46	$\overline{PWR\_DWN}$
4	X_IN		45	V_SS
5	X_OUT		44	XCPUCLK0
6	V_DDQ3		43	XCPUCLK1
7	PCICLK0		42	V_DDCPU
8	PCICLK1		41	XCPUCLK2
9	V_SS		40	XCPUCLK3
10	PCICLK2		39	V_SS
11	PCICLK3		38	CPUCLK0
12	PCICLK4		37	CPUCLK1
13	PCICLK5		36	V_DDQ3
14	V_DDQ3		35	CPUCLK2
15	PCICLK6		34	SEL0
16	V_SS		33	V_SS
17	PCICLK7		32	SEL1
18	PCICLK8		31	V_SS
19	V_DDQ3		30	SEL2
20	PCICLK9		29	CPU_RUN
21	CLK8MHz		28	USB_RUN
22	V_DDQ3		27	PCI_RUN
23	USBCLK		26	AV_DD
24	IRCLK		25	V_SS

TSSOP Top View — 2278A-3L

Pin	Signal		Pin	Signal
1	REF1		48	V_DDQ2
2	REF0		47	IOAPIC
3	V_SS		46	$\overline{PWR\_DWN}$
4	X_IN		45	V_SS
5	X_OUT		44	XCPUCLK0
6	V_DDQ3		43	XCPUCLK1
7	PCICLK0_F		42	V_DDCPU
8	PCICLK1_F		41	XCPUCLK2
9	V_SS		40	XCPUCLK3
10	PCICLK2		39	V_SS
11	PCICLK3		38	CPUCLK0
12	PCICLK4		37	CPUCLK1
13	PCICLK5		36	V_DDQ3
14	V_DDQ3		35	CPUCLK2
15	PCICLK6		34	SEL0
16	V_SS		33	V_SS
17	PCICLK7		32	SEL1
18	PCICLK8		31	V_SS
19	V_DDQ3		30	SEL2
20	PCICLK9		29	CPU_RUN
21	CLK8MHz		28	USB_RUN
22	V_DDQ3		27	PCI_RUN
23	USBCLK		26	AV_DD
24	IRCLK		25	V_SS

TSSOP Top View — 2278A-4L

Pin	Signal		Pin	Signal
1	REF1		48	V_DDQ2
2	REF0		47	IOAPIC
3	V_SS		46	$\overline{PWR\_DWN}$
4	X_IN		45	V_SS
5	X_OUT		44	XCPUCLK0
6	V_DDQ3		43	XCPUCLK1
7	PCICLK0_F		42	V_DDCPU
8	PCICLK1_F		41	XCPUCLK2
9	V_SS		40	XCPUCLK3
10	PCICLK2		39	V_SS
11	PCICLK3		38	CPUCLK0
12	PCICLK4		37	CPUCLK1
13	PCICLK5		36	V_DDQ3
14	V_DDQ3		35	CPUCLK2
15	PCICLK6		34	SEL0
16	V_SS		33	V_SS
17	PCICLK7		32	SEL1
18	PCICLK8		31	V_SS
19	V_DDQ3		30	SEL2
20	PCICLK9		29	CPU_RUN
21	CLK8MHz		28	USB_RUN
22	V_DDQ3		27	PCI_RUN
23	USBCLK		26	AV_DD
24	IRCLK		25	V_SS

Pin Summary

Name	Pins	Description
V_{DDQ3}	6, 14, 19, 22, 36	3.3V Digital voltage supply
V_{DDQ2}	48	IOAPIC Digital voltage supply, 2.5V
V_{DDCPU}	42	CPU Digital voltage supply, 2.5V or 3.3V
AV_{DD}	26	Analog voltage supply, 3.3V
V_{SS}	3, 9, 16, 25, 31, 33, 39, 45	Ground
XTALIN[3]	4	Reference crystal input
XTALOUT[3]	5	Reference crystal feedback
SEL2	30	CPU clock frequency select input, bit 2
SEL1	32	CPU clock frequency select input, bit 1
SEL0	34	CPU clock frequency select input, bit 0
PCI_RUN	27	Control input, stops all PCI clocks except PCICLK_F when driven LOW
USB_RUN	28	Control input, stops all USB/IR clocks when driven LOW
CPU_RUN	29	Control input, stops all CPU clocks except XCPUCLK_F when driven LOW
PWR_DWN	46	Power down input, shuts down device when driven LOW
XCPUCLK[0:2]	44, 43, 41	2.5V or 3.3V CPU clock outputs
XCPUCLK3_F	40	2.5V or 3.3V CPU clock output, free-running on CY2278A-1L only. This output is not free-running on the -2L, -3L, -4L configurations.
CPUCLK[0:2]	38, 37, 35	3.3V CPU clock output
PCICLK[2:9]	10, 11, 12, 13, 15, 17, 18, 20	PCI clock outputs
PCICLK_F[0:1]	7, 8	PCI clock outputs, free-running on CY2278A-1L, -3L, -4L only. This output is not free-running on the -2L configuration
CLK8MHZ	21	8-MHz Keyboard clock output
IOAPIC	47	IOAPIC clock output
REF[0:1]	2, 1	Reference clock outputs, 14.318 MHz. REF0 has high drive
USBCLK/IRCLK	23, 24	USB or IR clock outputs, 48 MHz

Function Table

SEL2	SEL1	SEL0	XTALIN	CPUCLK	PCICLK	REF IOAPIC	USBCLK IRCLK	CLK8MHZ
0	0	0	14.318 MHz	75.0 MHz	37.5 MHz	14.318 MHz	48.0 MHz	8.0 MHz
0	0	1	14.318 MHz	20.0 MHz	10.0 MHz	14.318 MHz	48.0 MHz	8.0 MHz
0	1	0	14.318 MHz	25 MHz	12.5 MHz	14.318 MHz	48.0 MHz	8.0 MHz
0	1	1	14.318 MHz	33.33 MHz	16.67 MHz	14.318 MHz	48.0 MHz	8.0 MHz
1	0	0	14.318 MHz	50.0 MHz	25.0 MHz	14.318 MHz	48.0 MHz	8.0 MHz
1	0	1	14.318 MHz	60.0 MHz	30.0 MHz	14.318 MHz	48.0 MHz	8.0 MHz
1	1	0	14.318 MHz	66.67 MHz	33.33 MHz	14.318 MHz	48.0 MHz	8.0 MHz
1	1	1	14.318 MHz	40.0 MHz	20.0 MHz	14.318 MHz	48.0 MHz	8.0 MHz

Note:
3. For best accuracy, use a parallel-resonant crystal, C_{LOAD} = 18 pF.

Actual Clock Frequency Values

Clock Output	Target Frequency (MHz)	Actual Frequency (MHz)	PPM
CPUCLK(0,0,0)	75.0	75.0	0
CPUCLK(0,0,1)	20.0	19.979	−1057
CPUCLK(0,1,0)	25	24.974	−1057
CPUCLK(0,1,1)	33.33	33.298	−1107
CPUCLK(1,0,0)	50.0	49.947	−1057
CPUCLK(1,0,1)	60.0	60.0	0
CPUCLK(1,1,0)	66.67	66.654	−171
CPUCLK(1,1,1)	40.0	39.992	−196
USBCLK[4]	48.0	48.008	167
CLK8MHz	8.0	8.001	167

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Supply Voltage .... −0.5 to +7.0V

Input Voltage .... −0.5V to V_{DD}+0.5

Storage Temperature (Non-Condensing) ... −65°C to +150°C

Junction Temperature .... +150°C

Package Power Dissipation 1W

Static Discharge Voltage .... >2000V
(per MIL-STD-883, Method 3015, like V_{DD} pins tied together)

Operating Conditions[5]

Parameter	Description	Min.	Max.	Unit
AV_{DD}, V_{DDQ3}	Analog and Digital Supply Voltage	3.135	3.465	V
V_{DDCPU}, V_{DDQ2}	CPU and IOAPIC Supply Voltage	2.375	2.625	V
T_A	Operating Temperature, Ambient	0	70	°C

C_L	Max. Capacitive Load on
	    XCPUCLK, CPUCLK, USBCLK/IRCLK, CLK8MHZ, REF1,
	    IOAPIC
	    PCICLK
	    REF0
			20
			20
			30
			45
				pF

$f_{(REF)}$	Reference Frequency, Oscillator Nominal Value	14.318	14.318	MHz
t_{PU}	Power-up time for all VDD's to reach minimum specified voltage (power ramps must be monotonic)	0.05	50	ms

Notes:
4. Meets Intel USB clock requirements.
5. Electrical parameters are guaranteed with these operating conditions.

Electrical Characteristics

Parameter	Description	Test Conditions			Min.	Max.	Unit
V_{IH}	High-level Input Voltage	Except Crystal Inputs[6]			2.0		V
V_{IL}	Low-level Input Voltage	Except Crystal Inputs[6]				0.8	V
V_{OH}	High-level Output Voltage	V_{DDCPU}, V_{DDQ2} = 2.375V	I_{OH} = 9 mA	XCPUCLK	2.0		V
			I_{OH} = 13 mA	IOAPIC			
V_{OL}	Low-level Output Voltage	V_{DDCPU}, V_{DDQ2} = 2.375V	I_{OL} = 13 mA	XCPUCLK		0.4	V
			I_{OL} = 18 mA	IOAPIC			
V_{OH}	High-level Output Voltage	V_{DDQ3}, AV_{DD}, V_{DDCPU} = 3.135V	I_{OH} = 23 mA	XCPUCLK	2.4		V
			I_{OH} = 23 mA	CPUCLK			
			I_{OH} = 23 mA	PCICLK			
			I_{OH} = 23 mA	USBCLK			
			I_{OH} = 23 mA	CLK8MHZ			
			I_{OH} = 23 mA	REF0			
			I_{OH} = 23 mA	REF1			
V_{OL}	Low-level Output Voltage	V_{DDQ3}, AV_{DD}, V_{DDCPU} = 3.135V	I_{OL} = 17 mA	XCPUCLK		0.4	V
			I_{OL} =17 mA	CPUCLK			
			I_{OL} = 17 mA	PCICLK			
			I_{OL} = 17 mA	USBCLK			
			I_{OL} = 17 mA	CLK8MHZ			
			I_{OL} = 17 mA	REF0			
			I_{OL} = 17 mA	REF1			
I_{IH}	Input High Current	V_{IH} = V_{DD}			−10	+10	μA
I_{IL}	Input Low Current	V_{IL} = 0V				10	μA
I_{DD}	Power Supply Current[7]	V_{DDQ3} = 3.465V, V_{IN} = 0 or V_{DD}, Loaded Outputs, CPU clocks = 66.67 MHz				200	mA
I_{DD}	Power Supply Current[7]	V_{DDQ3} = 3.465V, V_{IN} = 0 or V_{DD}, Unloaded Outputs				100	mA
I_{DDS}	Power-down Current	Current draw in power-down state				150	μA

Notes:
6. Crystal inputs have CMOS thresholds.
7. Power supply current will vary with number of outputs which are running. Therefore, power supply current can be calculated with the following formula: to be determined.

Switching Characteristics[8]

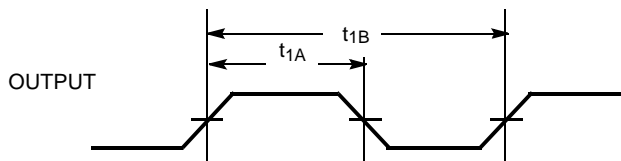| Parameter	Output	Description	Test Conditions	Min.	Typ.	Max.	Unit
t_1	All	Output Duty Cycle[9]	$t_1 = t_{1A} \div t_{1B}$	45	50	55	%
t_2	XCPUCLK	XCPU Clock Rising and Falling Edge Rate	Between 0.4V and 2.0V for 2.5V clocks	0.6		4.0	V/ns
t_2	CPUCLK, IOAPIC	CPU and IOAPIC Clock Rising and Falling Edge Rate	Between 0.4V and 2.0V for 2.5V clocks Between 0.4V and 2.4V for 3.3V clocks	0.8		4.0	V/ns
t_2	PCICLK	PCI Clock Rising and Falling Edge Rate	Between 0.4V and 2.4V	0.75		4.0	V/ns
t_2	USBCLK, CLK8MHZ	USB, CLK8MHZ Clock Rising and Falling Edge Rate	Between 0.4V and 2.4V	0.8		4.0	V/ns
t_2	REF0	REF0 Clock Rising and Falling Edge Rate	Between 0.4V and 2.4V	0.6		4.0	V/ns
t_2	REF1	REF1 Rising and Falling Edge Rate	Between 0.4V and 2.4V	0.5		2.0	V/ns
t_3	XCPUCLK	XCPU Clock Rise Time	Between 0.4V and 2.0V	0.4		2.67	ns
t_3	CPUCLK IOAPIC	CPU and IOAPIC Clock Rise Time	Between 0.4V and 2.4V for 3.3V clocks Between 0.4V and 2.0V for 2.5V clocks	0.5 0.4		2.5 2.0	ns
t_3	PCICLK	PCI Clock Rise Time	Between 0.4V and 2.4V	0.5		2.67	ns
t_3	USBCLK, CLK8MHZ	USB Clock and CLK8MHZ Rise Time	Between 0.4V and 2.4V			2.5	ns
t_4	XCPUCLK	XCPU Clock Fall Time	Between 2.0V and 0.4V	0.4		2.67	ns
t_4	CPUCLK, IOAPIC	CPU and IOAPIC Clock Fall Time	Between 2.4V and 0.4V for 3.3V clocks Between 2.0V and 0.4V for 2.5V clocks	0.5 0.4		2.5 2.0	ns
t_4	PCICLK	PCI Clock Fall Time	Between 2.4V and 0.4V	0.5		2.67	ns
t_4	USBCLK, CLK8MHZ	USB Clock and I/O Clock Fall Time	Between 2.4V and 0.4V			2.5	ns
t_5	XCPUCLK, CPUCLK	XCPU-XCPU Clock Skew CPU-CPU Clock Skew	Measured at 1.25V for 2.5V clocks Measured at 1.5V for 3.3V clocks		100	300 250	ps
t_5	PCICLK	PCI-PCI Clock Skew	Measured at 1.25V for 2.5V clocks, and at 1.5V for 3.3V clocks			500	ps
t_6	XCPUCLK, PCICLK	XCPU-PCI Clock Skew	Measured at 1.25V for 2.5V clocks, and at 1.5V for 3.3V clocks (-1L, -2L, -4L configurations)			500	ps
t_6	XCPUCLK, PCICLK	XCPU-PCI Clock Skew	Measured at 1.25V for 2.5V clocks, and at 1.5V for 3.3V clocks (-3L configuration)	1	3	5	ns
t_7	XCPUCLK, CPUCLK	CPU-XCPU Clock Skew	Measured at 1.25V for 2.5V clocks, and at 1.5V for 3.3V clocks			750	ps
t_8	XCPUCLK, CPUCLK	Cycle-Cycle Clock Jitter[10]	Measured at 1.25V for 2.5V clocks, and at 1.5V for 3.3V clocks			400	ps
t_8	USBCLK, PCICLK	Cycle-Cycle Clock Jitter	Measured at 1.5V			500	ps
t_8	CLK8MHZ	Cycle-Cycle Clock Jitter	Measured at 1.5V			650	ps
t_9	XCPUCLK, PCICLK, CPUCLK	Power-up Time	CPU, PCI clock stabilization from power-up			3	ms

Notes:
8. All parameters specified with loaded outputs; SEL[2:0] = 110.
9. Duty cycle is measured at 1.5V when V_{DD} = 3.3V. When V_{DDCPU} = 2.5V, CPUCLK duty cycle is measured at 1.25V.
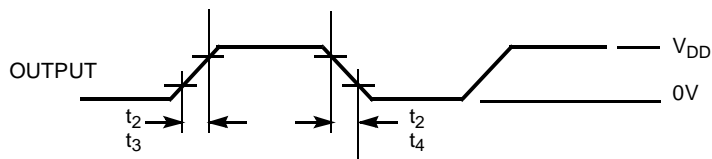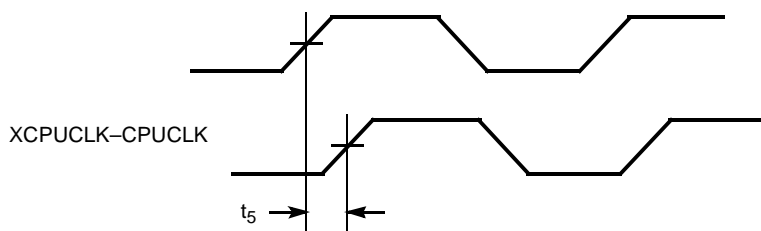10. Room Temperature.

Switching Waveforms

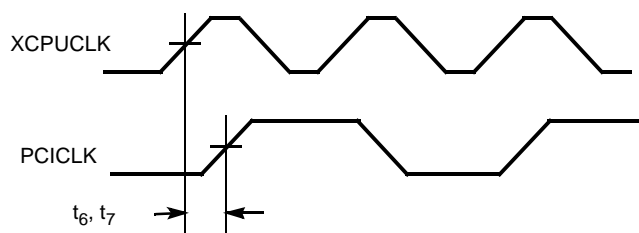### Duty Cycle Timing

All Outputs Rise/Fall Time

XCPU-CPU Clock Skew
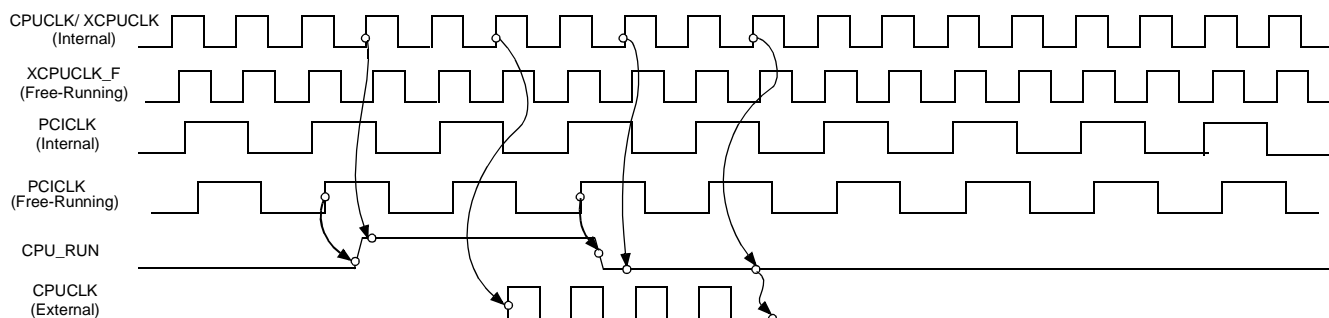

XCPU-PCI Clock Skew
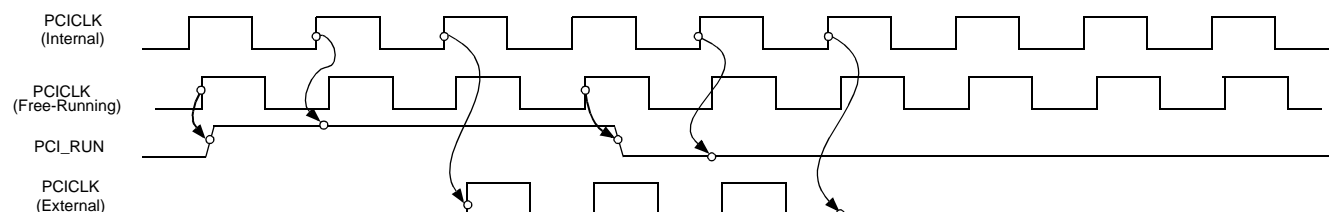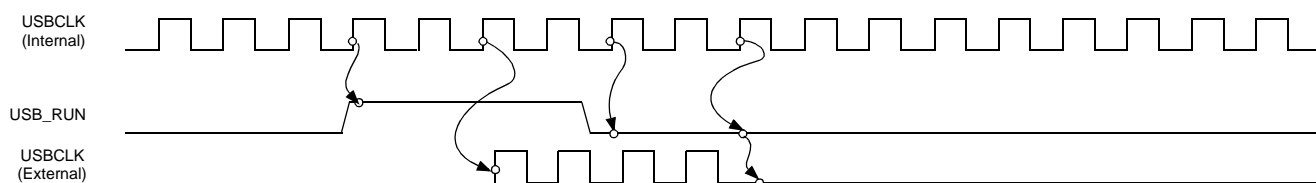
Switching Waveforms (continued)

CPU_RUN Timing[11, 12]

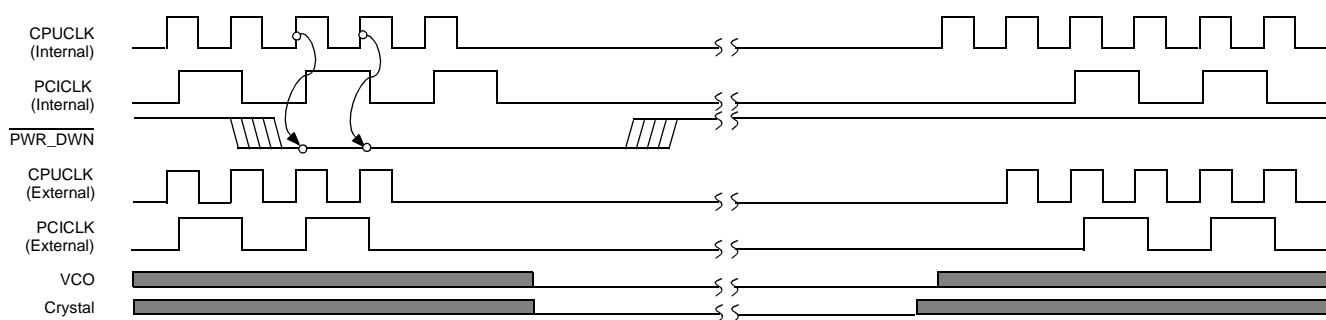CPUCLK/ XCPUCLK
(Internal)

XCPUCLK_F
(Free-Running)

PCICLK
(Internal)

PCICLK
(Free-Running)

CPU_RUN

CPUCLK
(External)

PCI_RUN Timing[13, 14]

PCICLK
(Internal)

PCICLK
(Free-Running)

PCI_RUN

PCICLK
(External)

USB_RUN Timing[15]

USBCLK
(Internal)

USB_RUN

USBCLK
(External)

PWR_DWN Timing

CPUCLK
(Internal)

PCICLK
(Internal)

$\overline{PWR\_DWN}$

CPUCLK
(External)

PCICLK
(External)

VCO

Crystal

Shaded section on the VCO and Crystal waveforms indicates that the VCO and crystal oscillator are active, and there is a valid clock.

Notes:
11. CPUCLK on and CPUCLK off latency is two or three external CPUCLK cycles.
12. CPU_RUN may be applied asynchronously. It is synchronized internally.
13. PCICLK on and PCICLK off latency is one rising edge of the external PCICLK.
14. PCI_RUN may be applied asynchronously. It is synchronized internally.
15. USBCLK on and USBCLK off latency is two USBCLK cycles.

Application Information

Clock traces must be terminated with either series or parallel termination, as is normally done.

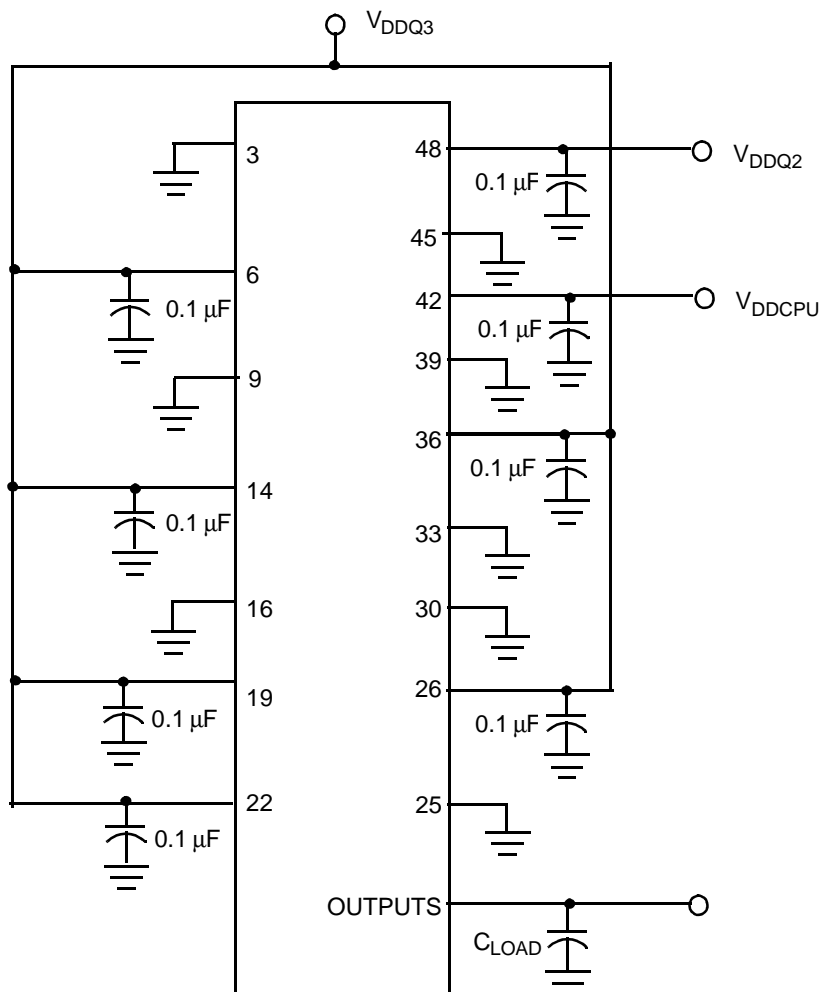## Application Circuit

Cd = DECOUPLING CAPACITORS

Ct = OPTIONAL EMI-REDUCING CAPACITORS

Cx = OPTIONAL LOAD MATCHING CAPACITOR

Rs = SERIES TERMINATING RESISTORS

Summary

- A parallel-resonant crystal should be used as the reference to the clock generator. The operating frequency and C_{LOAD} of this crystal should be as specified in the data sheet. Optional trimming capacitors may be needed if a crystal with a different C_{LOAD} is used. Footprints must be laid out for flexibility.

- Surface mount, low-ESR, ceramic capacitors should be used for filtering. Typically, these capacitors have a value of 0.1 µF. In some cases, smaller value capacitors may be required.

- The value of the series terminating resistor satisfies the following equation, where R_{trace} is the loaded characteristic impedance of the trace, R_{out} is the output impedance of the clock generator (specified in the data sheet), and R_{series} is the series terminating resistor.

$$R_{series} \geq R_{trace} - R_{out}$$

- Footprints must be laid out for optional EMI-reducing capacitors, which should be placed as close to the terminating resistor as is physically possible. Typical values of these capacitors range from 4.7 pF to 22 pF.

- A Ferrite Bead may be used to isolate the Board V_{DD} from the clock generator V_{DD} island. Ensure that the Ferrite Bead offers greater than 50Ω impedance at the clock frequency, under loaded DC conditions. Please refer to the application note "Layout and Termination Techniques for Cypress Clock Generators" for more details.

- If a Ferrite Bead is used, a 10 µF– 22 µF tantalum bypass capacitor should be placed close to the Ferrite Bead. This capacitor prevents power supply droop during current surges.
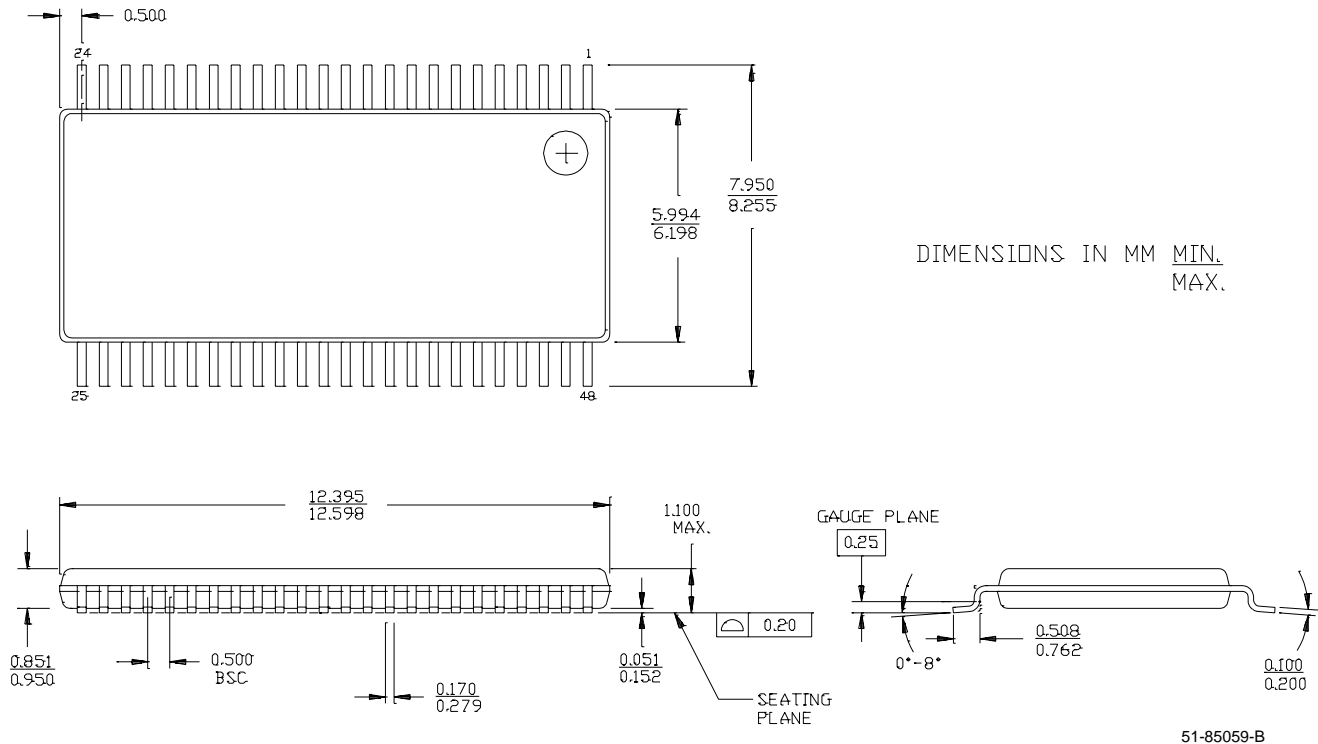
Test Circuit

Note: All capacitors should be placed as close to each pin as possible.

Ordering Information

Ordering Code	Package Name	Package Type	Operating Range
CY2278APAC-1L	Z48	48-Pin TSSOP	Commercial
CY2278APAC-2L	Z48	48-Pin TSSOP	Commercial
CY2278APAC-3L	Z48	48-Pin TSSOP	Commercial
CY2278APAC-4L	Z48	48-Pin TSSOP	Commercial

Package Diagram

48-Lead Thin Shrunk Small Outline Package, Type II (6 mm x 12 mm) Z48

DIMENSIONS IN MM MIN.
MAX.

51-85059-B

Document Title: CY2278A Pentium®/II Clock Synthesizer/Driver for Mobile PCs with Intel® 82430TX and No SDRAM
Document Number: 38-07211

REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	111728	12/15/01	DSG	Change from Spec number: 38-00619 to 38-07211
*A	121844	12/14/02	RBI	Power up requirements added to Operating Conditions Information